

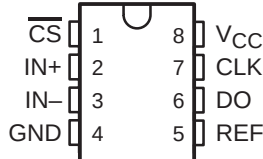
TLC0831C, TLC0831I TLC0832C, TLC0832I

8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

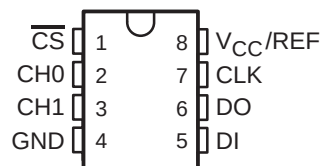
SLAS107B – JANUARY 1995 – REVISED APRIL 1996

- 8-Bit Resolution
- Easy Microprocessor Interface or Standalone Operation
- Operates Ratiometrically or With 5-V Reference
- Single Channel or Multiplexed Twin Channels With Single-Ended or Differential Input Options
- Input Range 0 to 5 V With Single 5-V Supply
- Inputs and Outputs Are Compatible With TTL and MOS
- Conversion Time of 32 μ s at $f_{\text{clock}} = 250$ kHz
- Designed to Be Interchangeable With National Semiconductor ADC0831 and ADC0832
- Total Unadjusted Error . . . ± 1 LSB

TLC0831 . . . D OR P PACKAGE
(TOP VIEW)



TLC0832 . . . D OR P PACKAGE
(TOP VIEW)



description

These devices are 8-bit successive-approximation analog-to-digital converters. The TLC0831 has single input channels; the TLC0832 has multiplexed twin input channels. The serial output is configured to interface with standard shift registers or microprocessors.

The TLC0832 multiplexer is software configured for single-ended or differential inputs. The differential analog voltage input allows for common-mode rejection or offset of the analog zero input voltage value. In addition, the voltage reference input can be adjusted to allow encoding any smaller analog voltage span to the full 8 bits of resolution.

The operation of the TLC0831 and TLC0832 devices is very similar to the more complex TLC0834 and TLC0838 devices. Ratiometric conversion can be attained by setting the REF input equal to the maximum analog input signal value, which gives the highest possible conversion resolution. Typically, REF is set equal to V_{CC} (done internally on the TLC0832).

The TLC0831C and TLC0832C are characterized for operation from 0°C to 70°C. The TLC0831I and TLC0832I are characterized for operation from –40°C to 85°C.

AVAILABLE OPTIONS

T _A	PACKAGE			
	SMALL OUTLINE (D)		PLASTIC DIP (P)	
0°C to 70°C	TLC0831CD	TLC0832CD	TLC0831CP	TLC0832CP
–40°C to 85°C	TLC0831ID	TLC0832ID	TLC0831IP	TLC0832IP



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

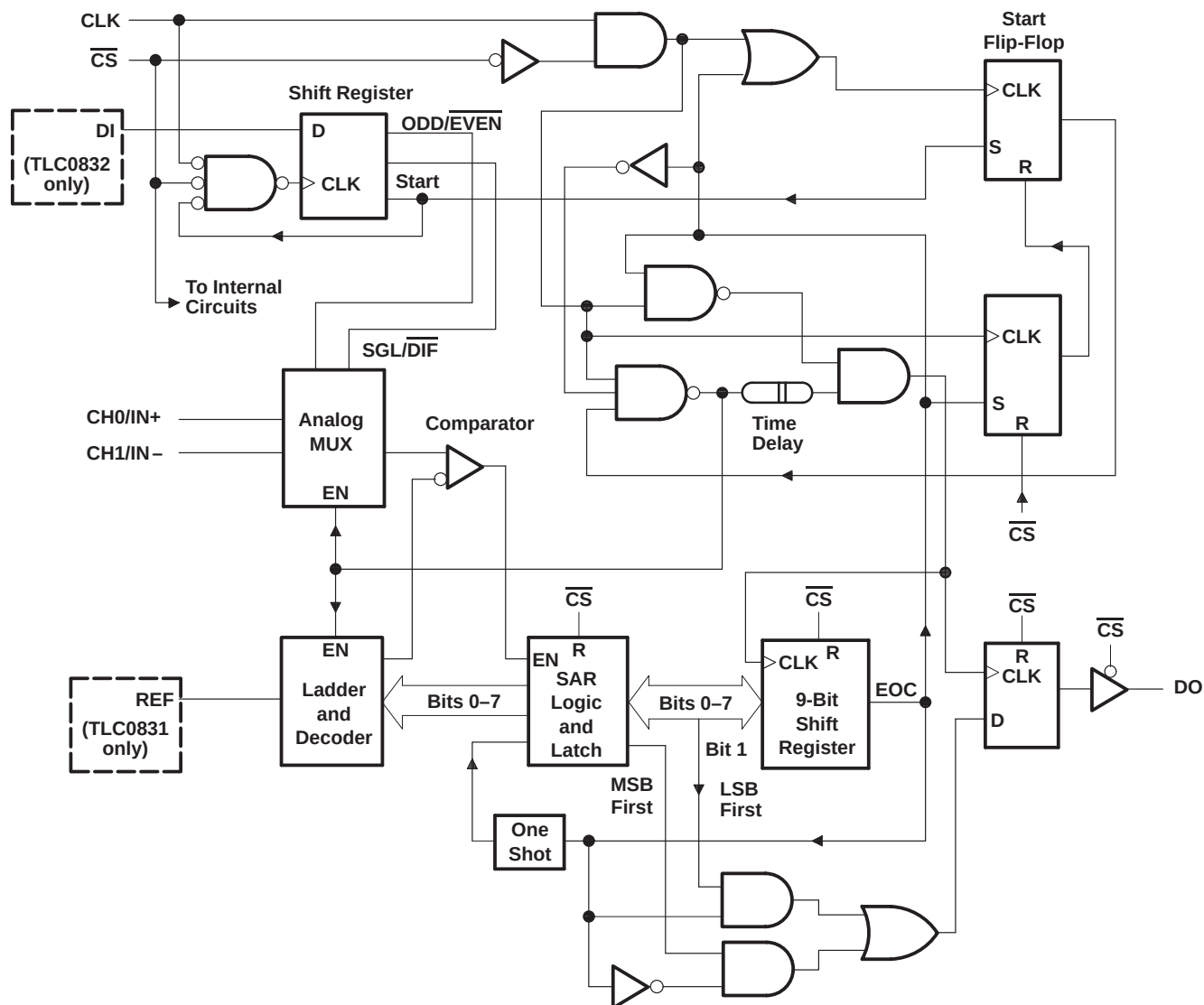
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TLC0831C, TLC0831I
TLC0832C, TLC0832I
8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL
 SLAS107B – JANUARY 1995 – REVISED APRIL 1996

functional block diagram



8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

SLAS107B – JANUARY 1995 – REVISED APRIL 1996

functional description

The TLC0831 and TLC0832 use a sample-data-comparator structure that converts differential analog inputs by a successive-approximation routine. The input voltage to be converted is applied to an input terminal and is compared to ground (single ended), or to an adjacent input (differential). The TLC0832 input terminals can be assigned a positive (+) or negative (–) polarity. The TLC0831 contains only one differential input channel with fixed polarity assignment; therefore it does not require addressing. The signal can be applied differentially, between IN+ and IN–, to the TLC0831 or can be applied to IN+ with IN– grounded as a single ended input. When the signal input applied to the assigned positive terminal is less than the signal on the negative terminal, the converter output is all zeros.

Channel selection and input configuration are under software control using a serial-data link from the controlling processor. A serial-communication format allows more functions to be included in a converter package with no increase in size. In addition, it eliminates the transmission of low-level analog signals by locating the converter at the analog sensor and communicating serially with the controlling processor. This process returns noise-free digital data to the processor.

A conversion is initiated by setting $\overline{CS}$ low, which enables all logic circuits. $\overline{CS}$ must be held low for the complete conversion process. A clock input is then received from the processor. An interval of one clock period is automatically inserted to allow the selected multiplexed channel to settle. DO comes out of the high-impedance state and provides a leading low for one clock period of multiplexer settling time. The SAR comparator compares successive outputs from the resistive ladder with the incoming analog signal. The comparator output indicates whether the analog input is greater than or less than the resistive-ladder output. As the conversion proceeds, conversion data is simultaneously output from DO, with the most significant bit (MSB) first. After eight clock periods, the conversion is complete. When $\overline{CS}$ goes high, all internal registers are cleared. At this time, the output circuits go to the high-impedance state. If another conversion is desired, $\overline{CS}$ must make a high-to-low transition followed by address information.

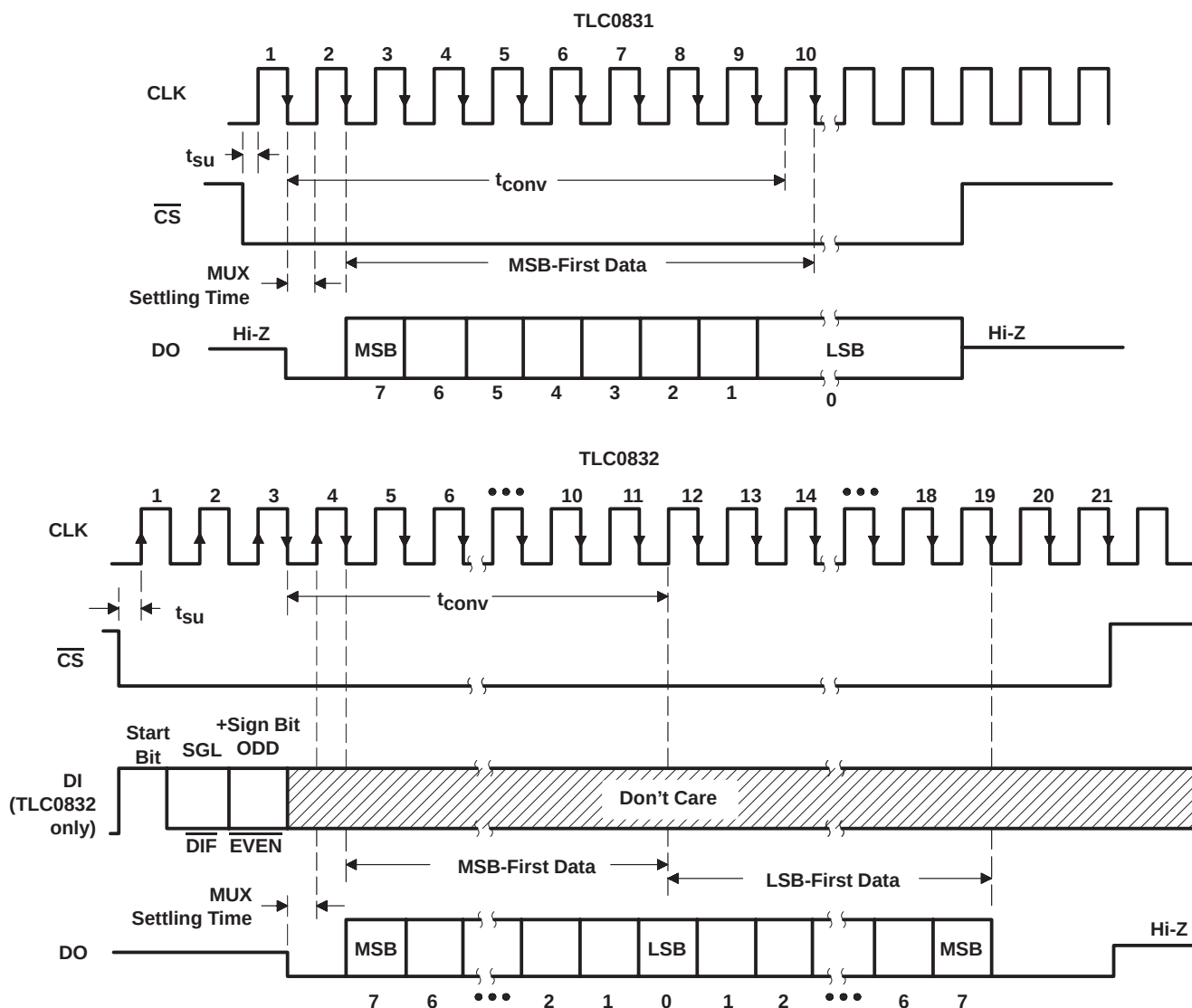
A TLC0832 input configuration is assigned during the multiplexer-addressing sequence. The multiplexer address shifts into the converter through the data input (DI) line. The multiplexer address selects the analog inputs to be enabled and determines whether the input is single ended or differential. When the input is differential, the polarity of the channel input is assigned. In addition to selecting the differential mode, the polarity may also be selected. Either channel of the channel pair may be designated as the negative or positive input.

On each low-to-high transition of the clock input, the data on DI is clocked into the multiplexer-address shift register. The first logic high on the input is the start bit. A 2-bit assignment word follows the start bit on the TLC0832. On each successive low-to-high transition of the clock input, the start bit and assignment word are shifted through the shift register. When the start bit is shifted into the start location of the multiplexer register, the input channel is selected and conversion starts. The TLC0832 DI terminal to the multiplexer shift register is disabled for the duration of the conversion.

The TLC0832 outputs the least-significant-bit (LSB) first data after the MSB-first data stream. The DI and DO terminals can be tied together and controlled by a bidirectional processor I/O bit received on a single wire. This is possible because DI is only examined during the multiplexer-addressing interval and DO is still in the high-impedance state.

TLC0831C, TLC0831I
TLC0832C, TLC0832I
8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL
 SLAS107B – JANUARY 1995 – REVISED APRIL 1996

sequence of operation



TLC0832 MUX-ADDRESS CONTROL LOGIC TABLE

MUX ADDRESS		CHANNEL NUMBER	
SGL/DIF	ODD/EVEN	CH0	CH1
L	L	+	–
L	H	–	+
H	L	+	
H	H		+

H = high level, L = low level,
 – or + = terminal polarity for the selected input channel

absolute maximum ratings over recommended operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	6.5 V
Input voltage range, V _I : Logic	-0.3 V to V _{CC} + 0.3 V
Analog	-0.3 V to V _{CC} + 0.3 V
Input current, I _I	±5 mA
Total input current	±20 mA
Operating free-air temperature range, T _A : C suffix	0°C to 70°C
I suffix	-40°C to 85°C
Storage temperature range, T _{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: P package	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential voltages, are with respect to the network ground terminal.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}		4.5	5	5.5	V
High-level input voltage, V_{IH}		2			V
Low-level input voltage, V_{IL}				0.8	V
Clock frequency, f_{clock}		10		600	kHz
Clock duty cycle (see Note 2)		40%		60%	
Pulse duration, $\overline{CS}$ high, $t_{WH}(CS)$		220			ns
Setup time, $\overline{CS}$ low or TLC0832 data valid before $CLK\uparrow$, t_{SU}		350			ns
Hold time, TLC0832 data valid after $CLK\uparrow$, t_H		90			ns
Operating free-air temperature, T_A	C suffix	0		70	°C
	I suffix	−40		85	

NOTE 2: The clock-duty-cycle range ensures proper operation at all clock frequencies. When a clock frequency is used outside the recommended duty-cycle range, the minimum pulse duration (high or low) is 1 μ s.

TLC0831C, TLC0831I
TLC0832C, TLC0832I
8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

SLAS107B – JANUARY 1995 – REVISED APRIL 1996

electrical characteristics over recommended range of operating free-air temperature, $V_{CC} = 5\text{ V}$, $f_{\text{clock}} = 250\text{ kHz}$ (unless otherwise noted)

digital section

PARAMETER		TEST CONDITIONS†	C SUFFIX			I SUFFIX			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VOH	High-level output voltage	VCC = 4.75 V, IOH = −360 μA	2.8			2.4			V
		VCC = 4.75 V, IOH = −10 μA	4.6			4.5			
VOL	Low-level output voltage	VCC = 4.75 V, IOL = 1.6 mA	0.34			0.4			V
IIH	High-level input current	VIH = 5 V	0.005			1			μA
IIL	Low-level input current	VIL = 0	−0.005			−1			μA
IOH	High-level output (source) current	VOH = VOIA = 25°C	−6.5 −24			−6.5 −24			mA
IOL	Low-level output (sink) current	VOL = VCC, TA = 25°C	8 26			8 26			mA
IOZ	High-impedance-state output current (DO)	VO = 5 V, TA = 25°C	0.01 3			0.01 3			μA
		VO = 0, TA = 25°C	−0.01 −3			−0.01 −3			
Ci	Input capacitance		5			5			pF
CO	Output capacitance		5			5			pF

† All parameters are measured under open-loop conditions with zero common-mode input voltage.

‡ All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

analog and converter section

PARAMETER		TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V_{IC}	Common-mode input voltage	See Note 3	-0.05 to $V_{CC}+0.05$			V
$I_{I(\text{stdby})}$	Standby input current (see Note 4)	On channel	$V_I = 5\text{ V}$			1
		Off channel	$V_I = 0$			-1
		On channel	$V_I = 0$			-1
		Off channel	$V_I = 5\text{ V}$			1
$r_{i(\text{REF})}$	Input resistance to REF		1.3	2.4	5.9	k Ω

† All parameters are measured under open-loop conditions with zero common-mode input voltage.

‡ All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

NOTES: 3. When channel IN- is more positive than channel IN+, the digital output code is 0000 0000. Connected to each analog input are two on-chip diodes that conduct forward current for analog input voltages one diode drop above V_{CC} . Care must be taken during testing at low V_{CC} levels (4.5 V) because high-level analog input voltage (5 V) can, especially at high temperatures, cause the input diode to conduct and cause errors for analog inputs that are near full scale. As long as the analog voltage does not exceed the supply voltage by more than 50 mV, the output code is correct. To achieve an absolute 0- to 5-V input range requires a minimum V_{CC} of 4.95 V for all variations of temperature and load.

4. Standby input currents go in or out of the on or off channels when the A/D converter is not performing conversion and the clock is in a high or low steady-state conditions.

total device

PARAMETER			MIN	TYP [‡]	MAX	UNIT
I _{CC}	Supply current	TLC0831		0.6	1.25	mA
		TLC0832		2.5	4.7	

‡ All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.



8-BIT ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL CONTROL

SLAS107B – JANUARY 1995 – REVISED APRIL 1996

operating characteristics $V_{CC} = V_{ref} = 5\text{ V}$, $f_{clock} = 250\text{ kHz}$, $t_r = t_f = 20\text{ ns}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	MIN	TYP	MAX	UNIT
Supply-voltage variation error			V _{CC} = 4.75 V to 5.25 V	± 1/16		± 1/4	LSB
Total unadjusted error (see Note 5)			V _{ref} = 5 V, T _A = MIN to MAX			± 1	LSB
Common-mode error			Differential mode	± 1/16		± 1/4	LSB
t _{pd}	Propagation delay time, output data after CLK↑ (see Note 6)	MSB-first data	C _L = 100 pF	650		1500	ns
		LSB-first data		250		600	
t _{dis}	Output disable time, DO after $\overline{CS}$ ↑	C _L = 10 pF, R _L = 10 kΩ		125		250	ns
		C _L = 100 pF, R _L = 2 kΩ				500	
t _{conv}	Conversion time (multiplexer-addressing time not included)					8	clock periods

[†] All parameters are measured under open-loop conditions with zero common-mode input voltage. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTES: 5. Total unadjusted error includes offset, full-scale, linearity, and multiplexer errors.

6. The MSB-first data is output directly from the comparator and, therefore, requires additional delay to allow for comparator response time. LSB-first data applies only to TLC0832.

PARAMETER MEASUREMENT INFORMATION

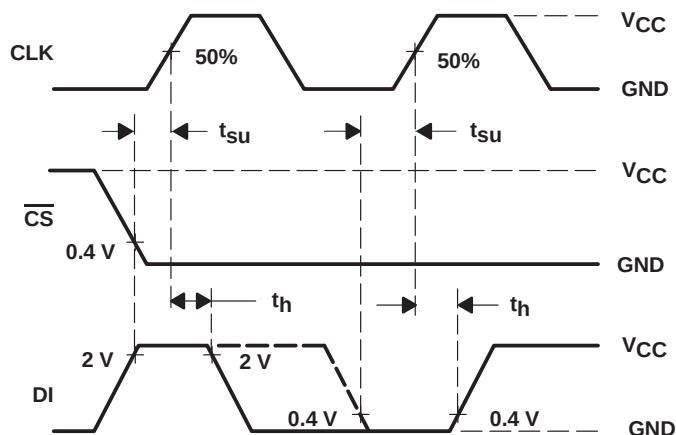


Figure 1. TLC0832 Data-Input Timing

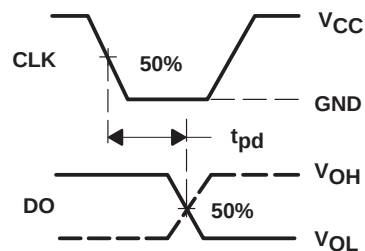
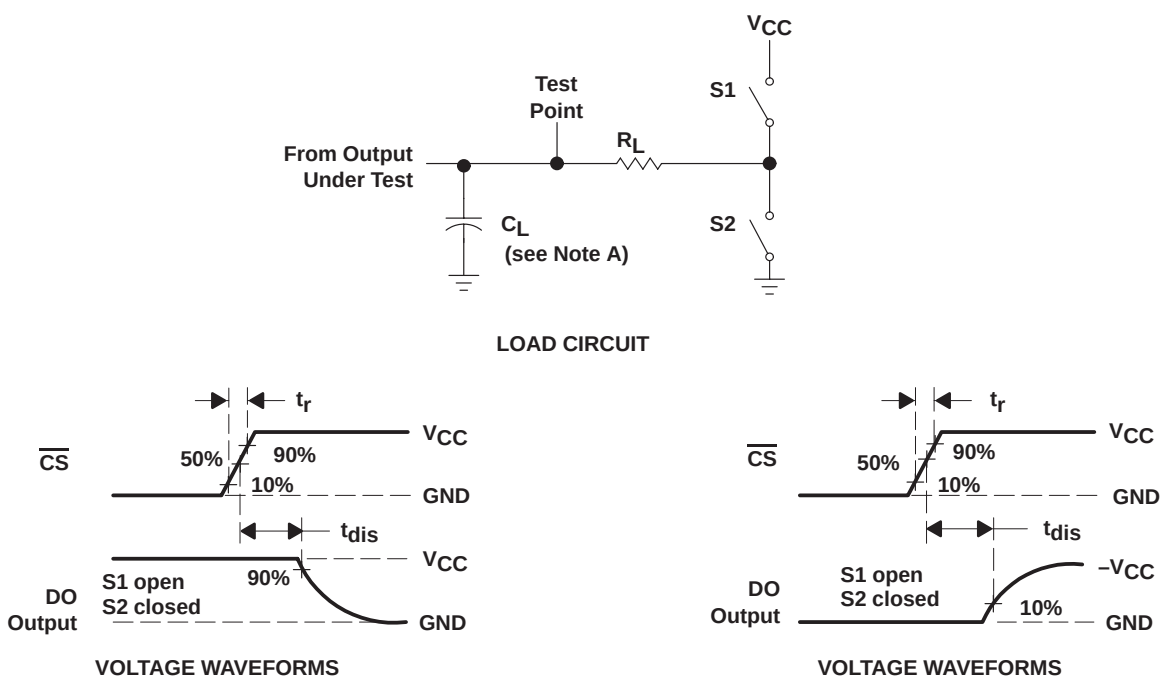


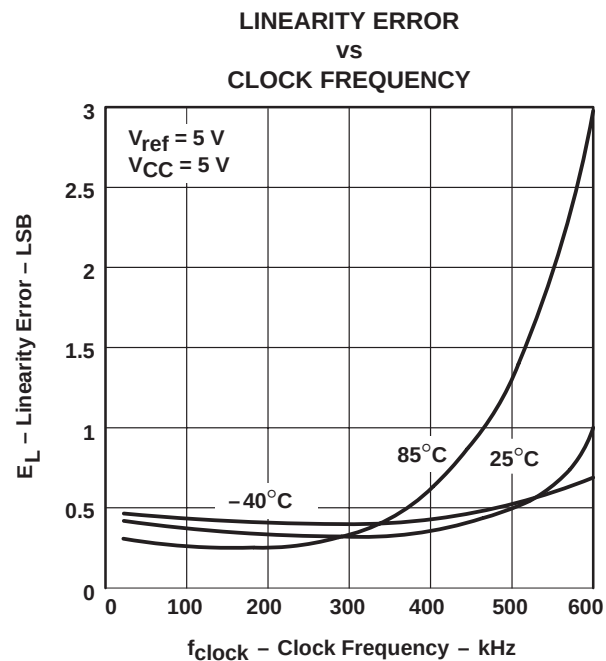
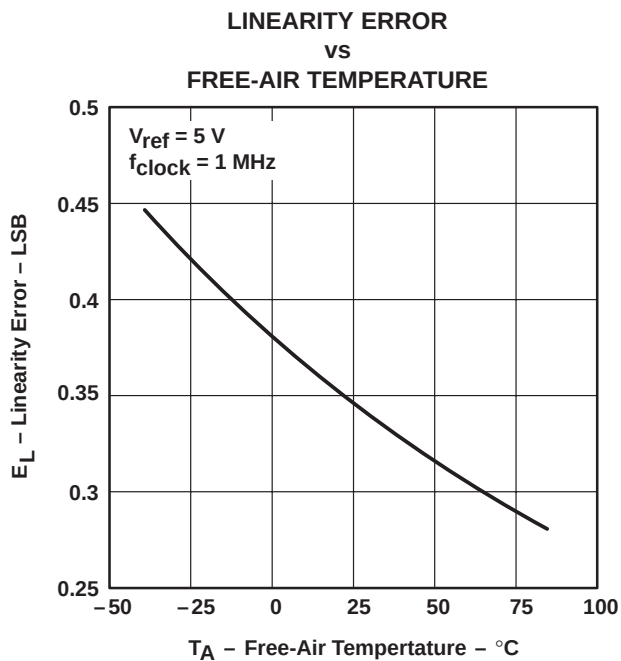
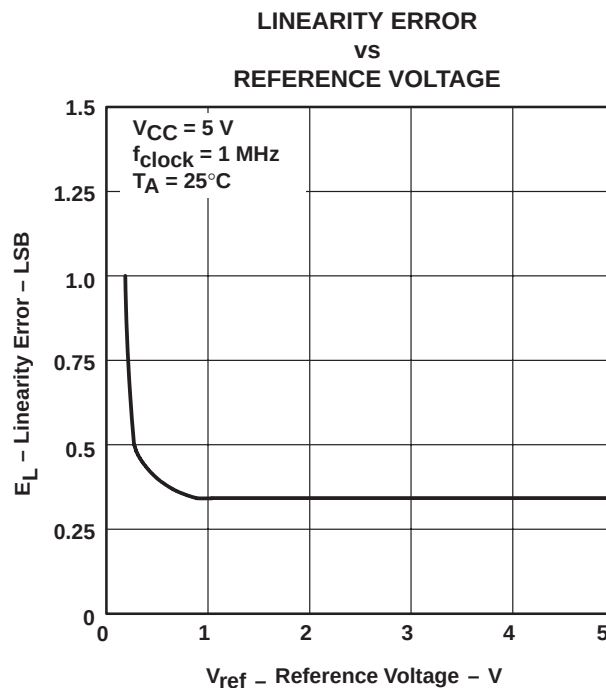
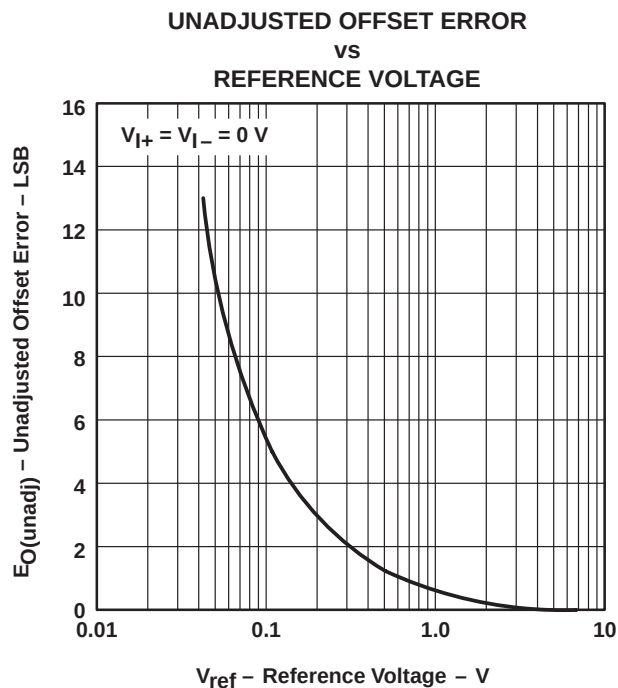
Figure 2. Data-Output Timing



NOTE A: C_L includes probe and jig capacitance.

Figure 3. Output Disable Time Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

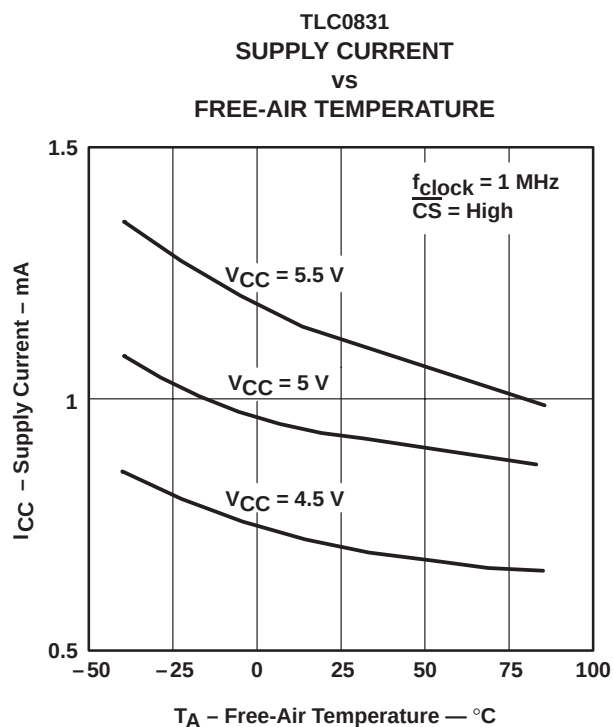


Figure 8

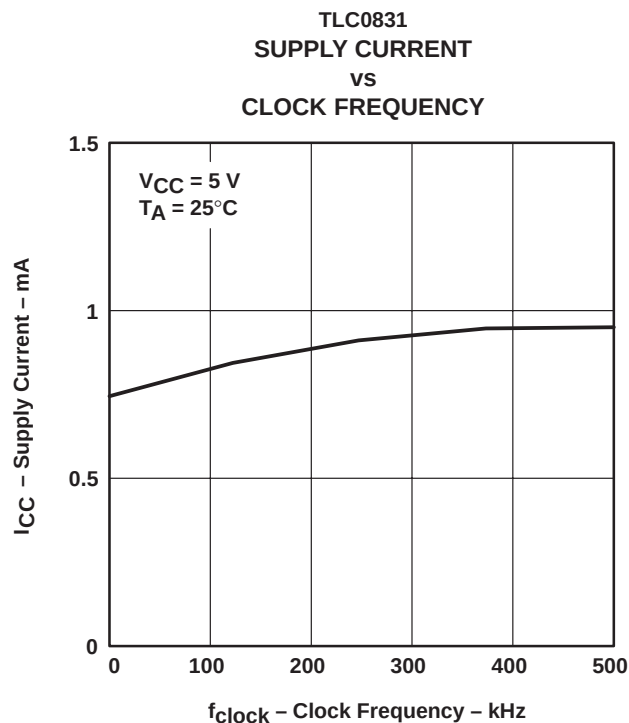


Figure 9

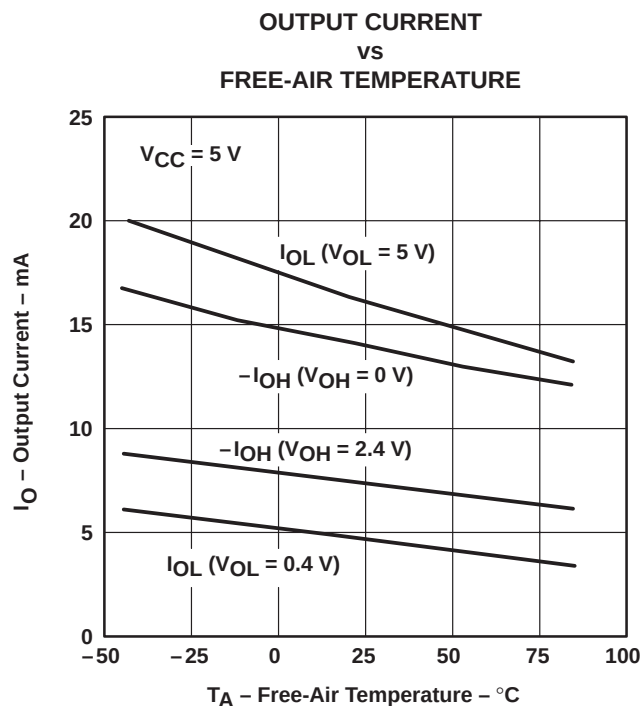


Figure 10

TYPICAL CHARACTERISTICS

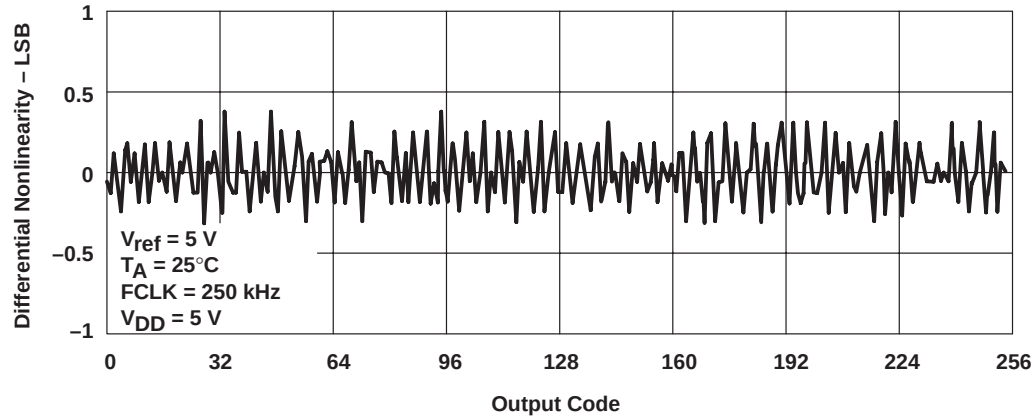


Figure 11. Differential Nonlinearity With Output Code

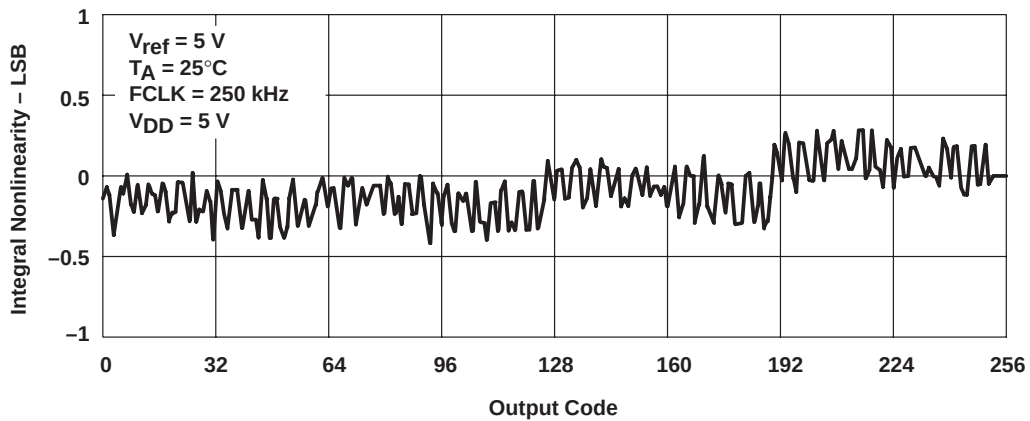


Figure 12. Integral Nonlinearity With Output Code

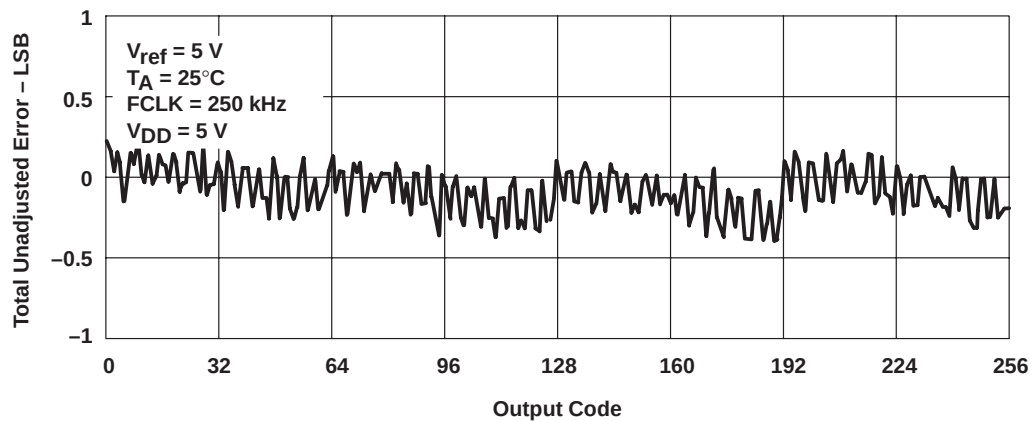


Figure 13. Total Unadjusted Error With Output Code

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TLC0831CD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0831C
TLC0831CD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0831C
TLC0831CDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0831C
TLC0831CDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0831C
TLC0831CP	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0831CP
TLC0831CP.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0831CP
TLC0831CPE4	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	See TLC0831CP	TLC0831CP
TLC0831ID	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	
TLC0831ID.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	
TLC0831IDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	
TLC0831IDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	
TLC0831IP	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0831IP
TLC0831IP.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0831IP
TLC0832CD	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832C
TLC0832CD.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832C
TLC0832CDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0832C
TLC0832CDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832C
TLC0832CP	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0832CP
TLC0832CP.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0832CP
TLC0832ID	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0832I
TLC0832ID.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832I
TLC0832IDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	C0832I
TLC0832IDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	C0832I
TLC0832IP	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TLC0832IP
TLC0832IP.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC0832IP
TLC0832IPE4	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	See TLC0832IP	TLC0832IP

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

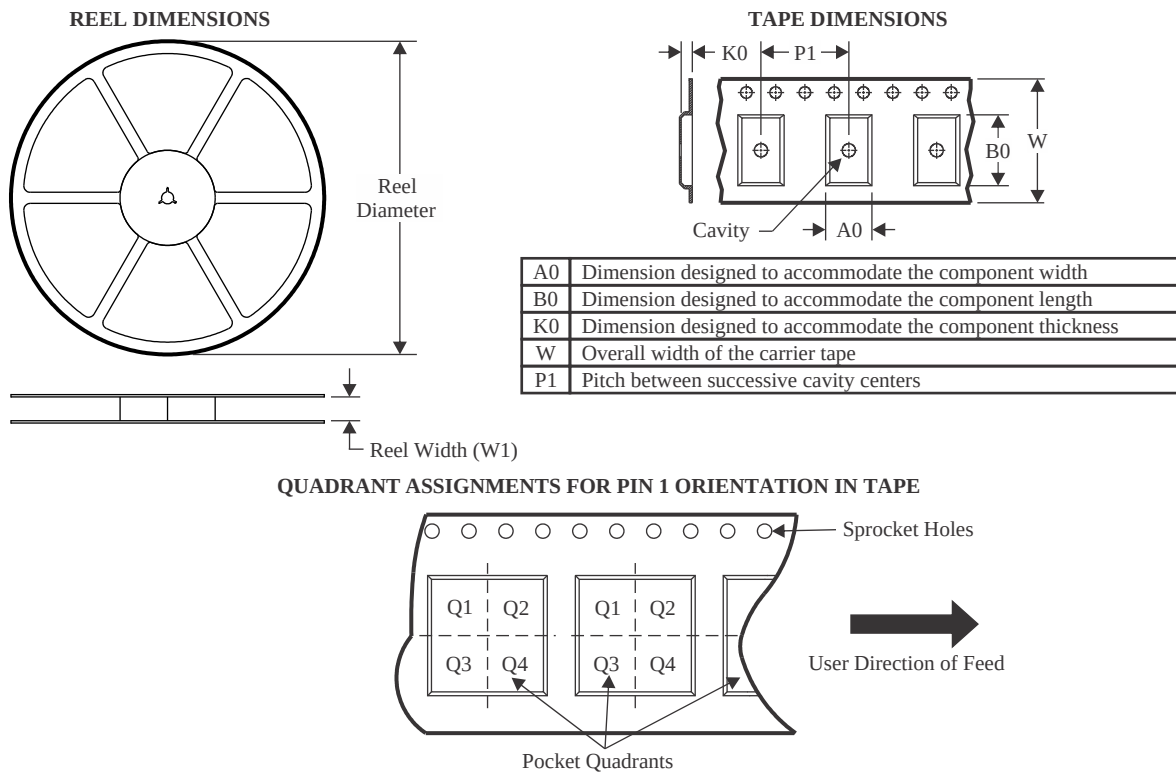
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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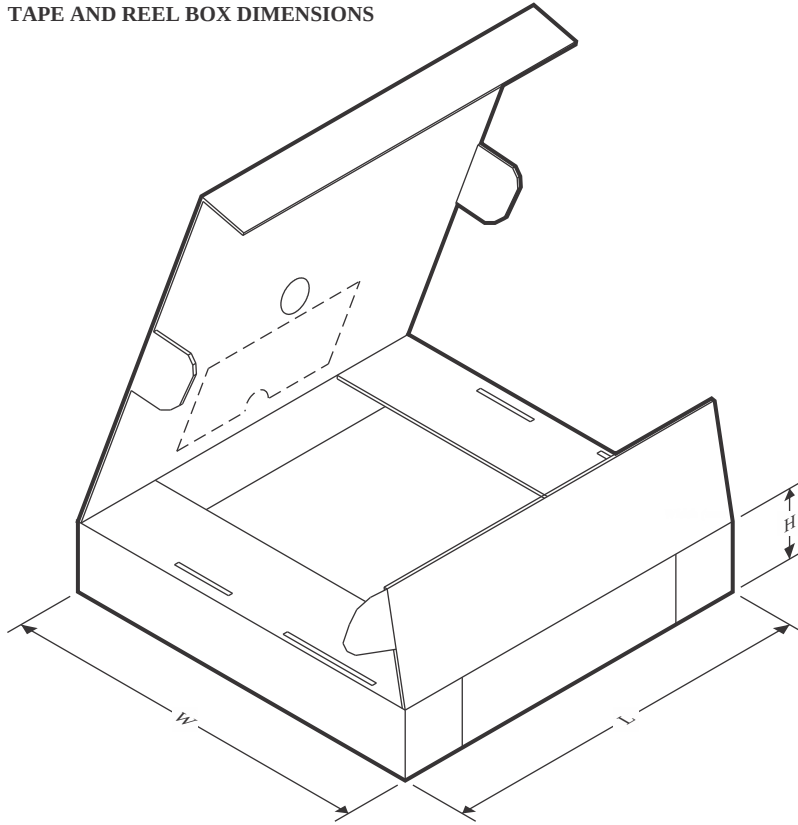
TAPE AND REEL INFORMATION



*All dimensions are nominal

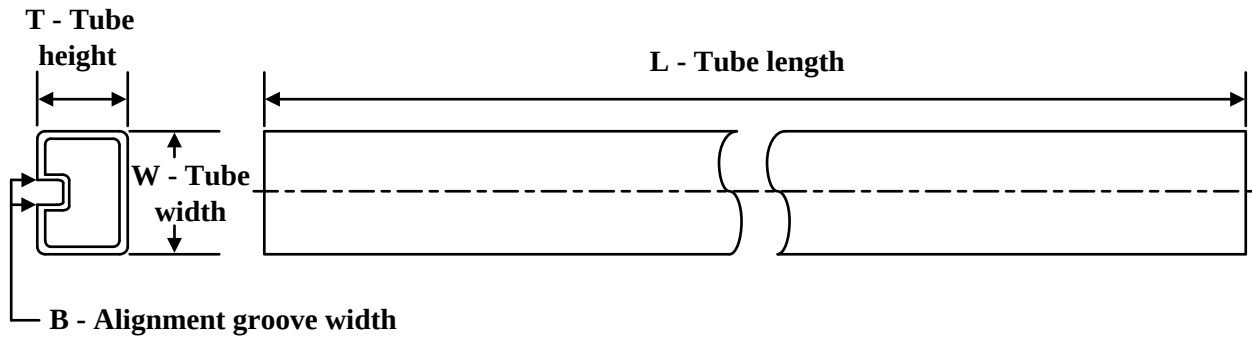
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC0831CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC0831IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC0832CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLC0832IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



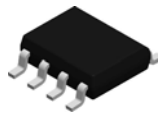
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC0831CDR	SOIC	D	8	2500	350.0	350.0	43.0
TLC0831IDR	SOIC	D	8	2500	350.0	350.0	43.0
TLC0832CDR	SOIC	D	8	2500	350.0	350.0	43.0
TLC0832IDR	SOIC	D	8	2500	350.0	350.0	43.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TLC0831CD	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831CD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831CP	P	PDIP	8	50	506	13.97	11230	4.32
TLC0831CP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLC0831CPE4	P	PDIP	8	50	506	13.97	11230	4.32
TLC0831ID	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831ID.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0831IP	P	PDIP	8	50	506	13.97	11230	4.32
TLC0831IP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLC0832CD	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832CD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832CP	P	PDIP	8	50	506	13.97	11230	4.32
TLC0832CP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLC0832ID	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832ID.A	D	SOIC	8	75	505.46	6.76	3810	4
TLC0832IP	P	PDIP	8	50	506	13.97	11230	4.32
TLC0832IP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLC0832IPE4	P	PDIP	8	50	506	13.97	11230	4.32

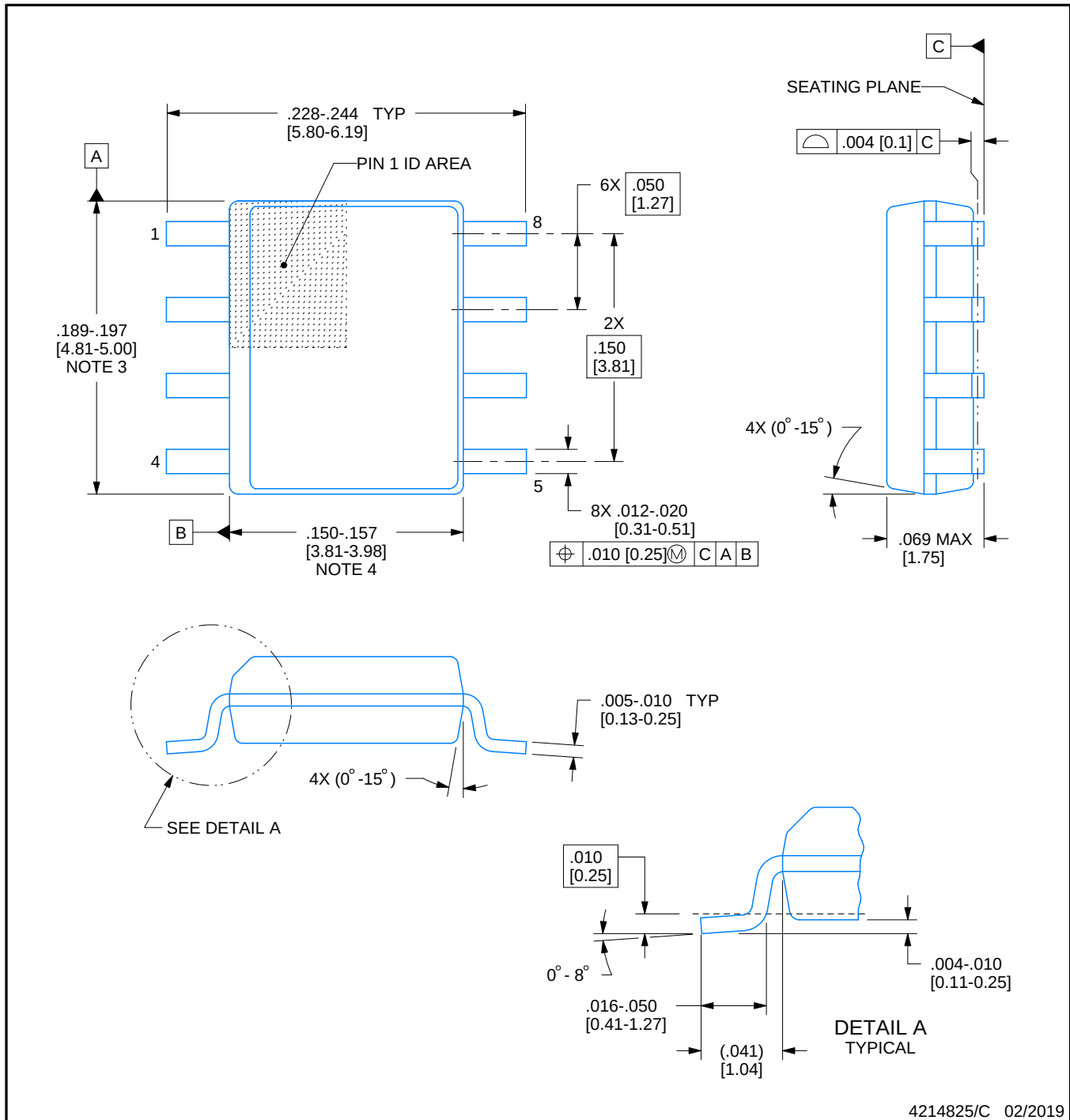


D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

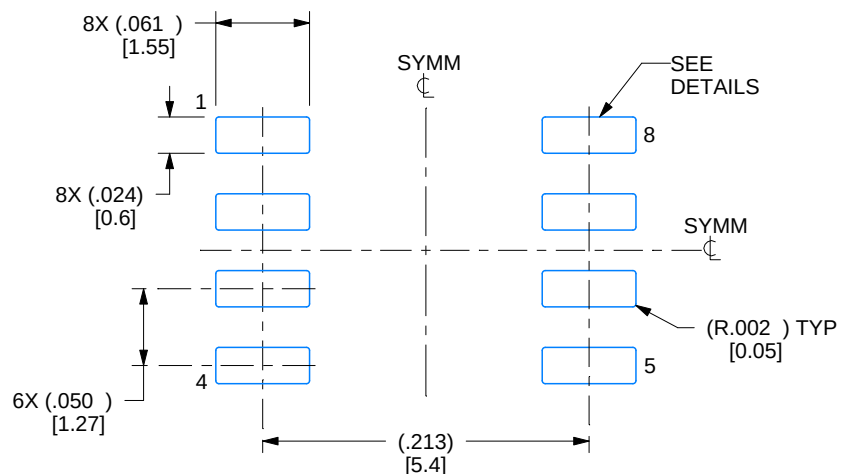
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

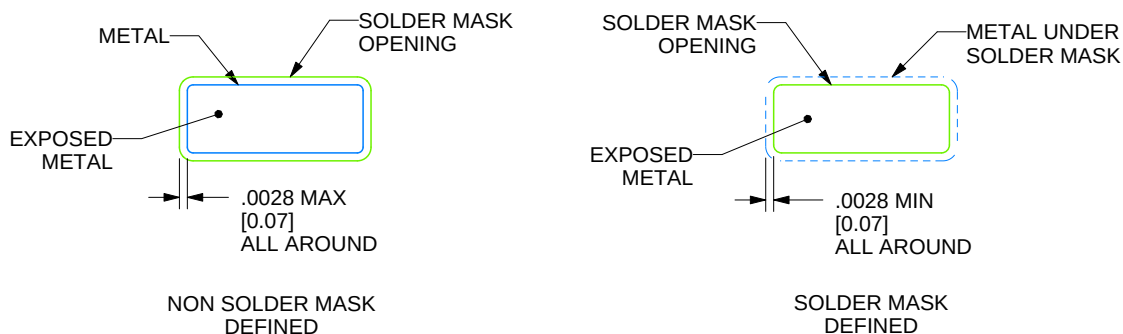
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

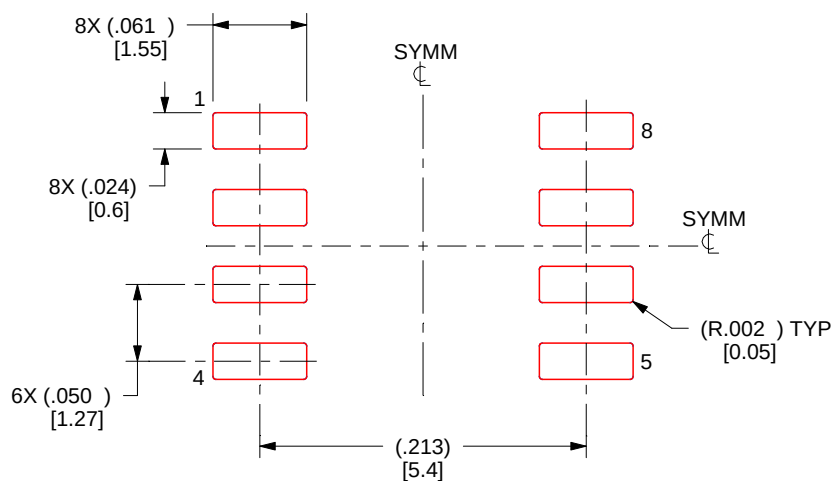
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

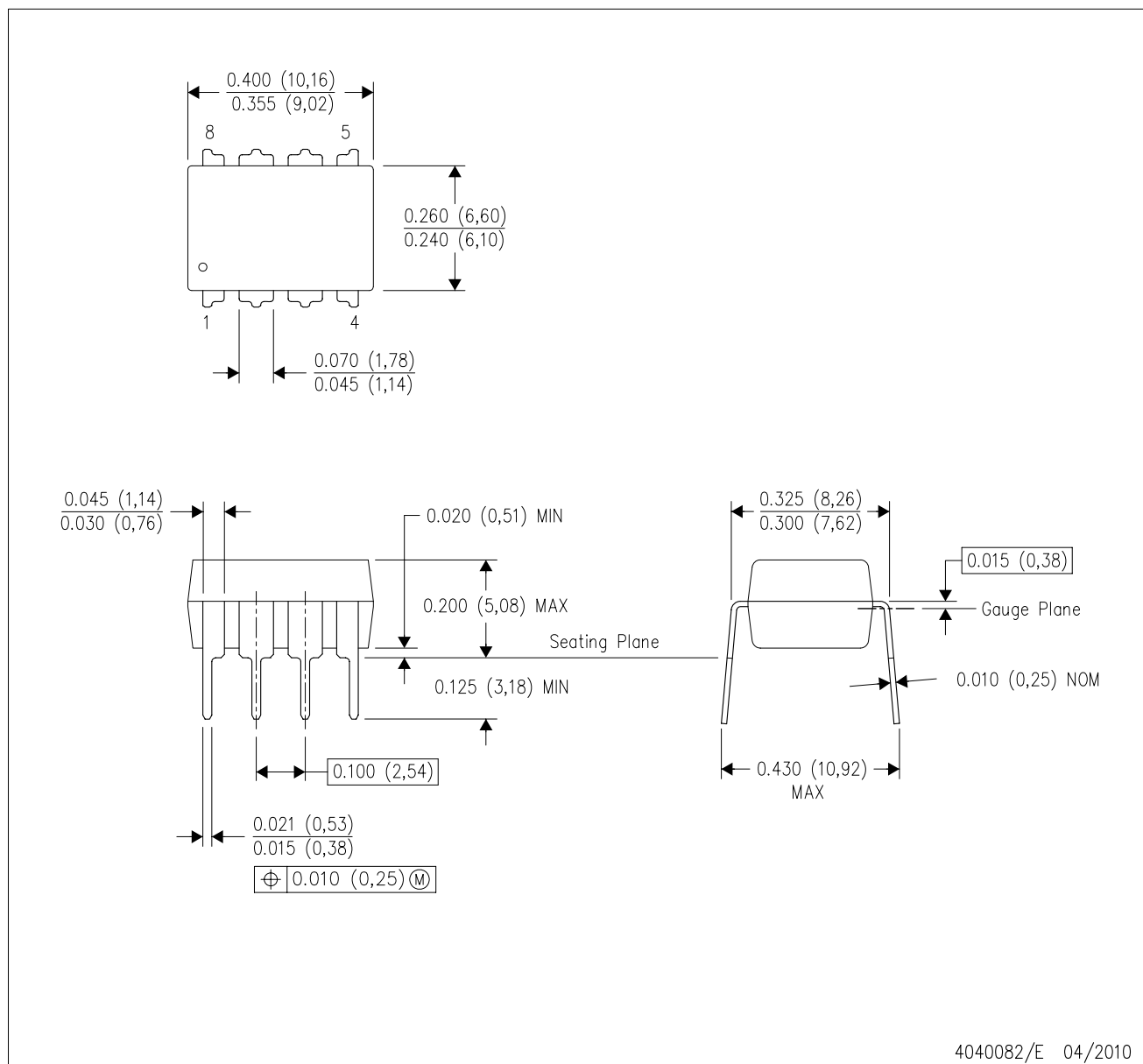
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

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